

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT6090534

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	EUNHYE KIM	04/29/2020
	SANGMOO PARK	04/29/2020
	MINSUB OH	04/20/2020
	DONGYEOB LEE	04/29/2020
	YOONSUK LEE	04/29/2020
RECEIVING PARTY DATA		
Name:	SAMSUNG ELECTRONICS CO., LTD.	
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO	
City:	SUWON-SI	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	16677	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	16866027	
CORRESPONDENCE DATA		
Fax Number:	(202)293-7860	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	2022937060	
Email:	cannes@sughrue.com, sughrue@sughrue.com	
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ATTORNEY DOCKET NUMBER:	Q254286	
NAME OF SUBMITTER:	CHRISTOPHER ANNES - TEAMS DEPARTMENT	
SIGNATURE:	/CHRISTOPHER ANNES/	
DATE SIGNED:	05/04/2020	
This document serves as an Oath/Declaration (37 CFR 1.63).		

Total Attachments: 6

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ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, We, the undersigned inventors hereinafter called assignors, have invented certain improvements described in the application identified below; and

Whereas, SAMSUNG ELECTRONICS CO., LTD. of 129, Samsung-ro, Yeongtong-gu, Gyeonggi-do, Suwon-si, 16677, Republic of Korea, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

We, the above named assignors, hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America and all other countries, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, and including rights of priority under the International Convention of Paris (1883) as amended, the laws of all foreign countries, and the laws of the United States including the right to claim priority under 35 USC 119 and the right to sue for past damages, and we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and we hereby agree that the assignee may apply for foreign Letters Patent on the invention and we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States and foreign applications when called upon to do so by the assignee.

(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261)

As the below named inventor, I hereby declare that:

This assignment with declaration is ☒ The attached application, or
directed to: ☐ United States Application or PCT International Application Number _____ filed
on _____.

The application is entitled:

MICRO LED TRANSFER METHOD AND DISPLAY MODULE MANUFACTURED BY THE SAME

The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

NAME OF SOLE OR FIRST INVENTOR:			
Given Name (first and middle [if any])		Family Name or Surname	
Doyoung		KWAG	
Inventor's signature		Date	
<i>Doyoung Kwag</i>		2020.4.29	
Residence: Suwon-si, Republic of Korea			
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NAME OF SECOND INVENTOR:			
Given Name (first and middle [if any])		Family Name or Surname	
Byungchul		KIM	
Inventor's signature		Date	
<i>Byungchul Kim</i>		2020.4.29	
Residence: Suwon-si, Republic of Korea			
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea			
NAME OF THIRD INVENTOR:			
Given Name (first and middle [if any])		Family Name or Surname	
Eunhye		KIM	
Inventor's signature		Date	
<i>Eunhye Kim</i>		2020.4.29	
Residence: Suwon-si, Republic of Korea			
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea			
NAME OF FOURTH INVENTOR:			
Given Name (first and middle [if any])		Family Name or Surname	
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Inventor's signature		Date	
<i>Sangmoon Park</i>		2020.4.29	
Residence: Suwon-si, Republic of Korea			
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea			
NAME OF FIFTH INVENTOR:			
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Inventor's signature		Date	
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Mailing Address: 101, 11, Gangnam-daero 48-gil, Gangnam-gu, Seoul, 06265, Republic of Korea			

NAME OF SIXTH INVENTOR:	
Given Name (first and middle [if any]) Dongyeob	Family Name or Surname LEE
Inventor's signature <i>Dong yeob Lee</i>	Date 2020.4.29
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Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea	
NAME OF SEVENTH INVENTOR:	
Given Name (first and middle [if any]) Yoonsuk	Family Name or Surname LEE
Inventor's signature <i>yoonsuk lee</i>	Date 2020.4.29
Residence: Suwon-si, Republic of Korea	
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea	

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

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Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

We, the above named assignors, hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America and all other countries, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, and including rights of priority under the International Convention of Paris (1883) as amended, the laws of all foreign countries, and the laws of the United States including the right to claim priority under 35 USC 119 and the right to sue for past damages, and we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and we hereby agree that the assignee may apply for foreign Letters Patent on the invention and we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States and foreign applications when called upon to do so by the assignee.

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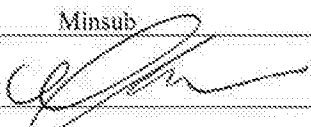
The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

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NAME OF SOLE OR FIRST INVENTOR:	
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NAME OF SEVENTH INVENTOR:	
Given Name (first and middle [if any]) Yoonsuk	Family Name or Surname LEE
Inventor's signature	Date
Residence: Suwon-si, Republic of Korea	
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea	